

1. PART NO. EXPRESSION :

S D I 3 2 2 5 2 0 - 1 R 0 M F

(a) (b) (c) (d)(e)

(a) Series code

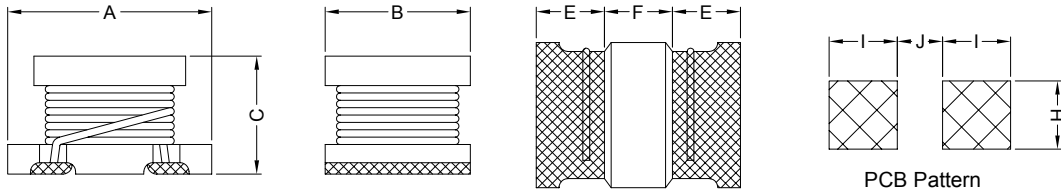
(b) Dimension code

(c) Inductance code : 1R0 = 1.0uH

(d) Tolerance code : J = ±5%, K = ±10%, M = ±20%

(e) F : Lead Free

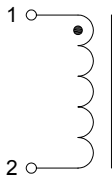
2. CONFIGURATION & DIMENSIONS :



Unit:m/m

A	B	C	E	F	H	I	J
3.2±0.3	2.5±0.2	2.0±0.3	0.7 Min.	0.7 Min.	2.0 Ref.	1.5 Ref.	1.0 Ref.

3. SCHEMATIC :



4. GENERAL SPECIFICATION :

- a) Ambient temp. : 20°C
- b) Operating temp. : -25°C to 85°C
- c) Rated current : Base on temp. rise & $\Delta L/L0A=10\%$ Max.



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5. ELECTRICAL CHARACTERISTICS :

Part No.	Inductance (uH)	Tolerance	Test Frequency (Hz)	Q Min.	Test Frequency (Hz)	SRF (MHz) Min.	DCR (Ω) Max.	IDC (mA) Max.
SDI322520-R10□F	0.10	M	1M	20	25.2M	200	0.25	700
SDI322520-R18□F	0.18	M	1M	20	25.2M	200	0.25	650
SDI322520-R27□F	0.27	M	1M	25	25.2M	200	0.25	600
SDI322520-R39□F	0.39	M	1M	25	25.2M	200	0.25	530
SDI322520-R56□F	0.56	M	1M	30	25.2M	160	0.25	530
SDI322520-R68□F	0.68	M	1M	30	25.2M	160	0.25	470
SDI322520-R82□F	0.82	M	1M	30	25.2M	120	0.25	450
SDI322520-1R0□F	1.0	M	1M	20	1M	100	0.50	445
SDI322520-1R2□F	1.2	M	1M	20	1M	100	0.60	425
SDI322520-1R5□F	1.5	M, K	1M	20	1M	75	0.60	400
SDI322520-1R8□F	1.8	M, K	1M	20	1M	60	0.70	390
SDI322520-2R2□F	2.2	M, K	1M	20	1M	50	0.80	370
SDI322520-2R7□F	2.7	M, K	1M	20	1M	43	0.90	320
SDI322520-3R3□F	3.3	M, K	1M	20	1M	38	1.0	300
SDI322520-3R9□F	3.9	M, K	1M	20	1M	35	1.1	290
SDI322520-4R7□F	4.7	M, K	1M	20	1M	31	1.2	270
SDI322520-5R6□F	5.6	M, K	1M	20	1M	28	1.3	250
SDI322520-6R8□F	6.8	M, K	1M	20	1M	25	1.5	240
SDI322520-8R2□F	8.2	M, K	1M	20	1M	23	1.6	225
SDI322520-100□F	10	K, J	1M	35	1M	20	1.8	190
SDI322520-120□F	12	K, J	1M	35	1M	18	2.0	180
SDI322520-150□F	15	K, J	1M	35	1M	16	2.2	170
SDI322520-180□F	18	K, J	1M	35	1M	15	2.5	165
SDI322520-220□F	22	K, J	1M	35	1M	14	2.8	150
SDI322520-270□F	27	K, J	1M	35	1M	13	3.1	125
SDI322520-330□F	33	K, J	1M	40	1M	12	3.5	115
SDI322520-390□F	39	K, J	1M	40	1M	11	3.9	110
SDI322520-470□F	47	K, J	1M	40	1M	11	4.3	100
SDI322520-560□F	56	K, J	1M	40	1M	10.0	4.9	85
SDI322520-680□F	68	K, J	1M	40	1M	9.0	5.5	80
SDI322520-820□F	82	K, J	1M	40	1M	8.5	6.2	70

Inductance tolerance :

- : J = $\pm 5\%$
- K = $\pm 10\%$
- M = $\pm 20\%$



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5. ELECTRICAL CHARACTERISTICS :

Part No.	Inductance (uH)	Tolerance	Test Frequency (Hz)	Q Min.	Test Frequency (Hz)	SRF (MHz) Min.	DCR (Ω) Max.	IDC (mA) Max.
SDI322520-101□F	100	K, J	1M	40	796K	8.0	7.0	80
SDI322520-121□F	120	K, J	1M	40	796K	7.5	8.0	75
SDI322520-151□F	150	K, J	1M	40	796K	7.0	9.3	70
SDI322520-181□F	180	K, J	1M	40	796K	6.0	10.2	65
SDI322520-221□F	220	K, J	1M	40	796K	5.5	11.8	65
SDI322520-271□F	270	K, J	1M	40	796K	5.0	12.5	65
SDI322520-331□F	330	K, J	1M	40	796K	5.0	15.0	65
SDI322520-391□F	390	K, J	1M	50	796K	5.0	22.0	50
SDI322520-471□F	470	K, J	1K	50	796K	5.0	25.0	45
SDI322520-561□F	560	K, J	1K	50	796K	5.0 (Ref.)	28.0	40

Inductance tolerance :

- : J = ±5%
- K = ±10%
- M = ±20%



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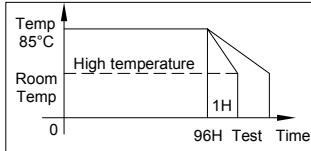
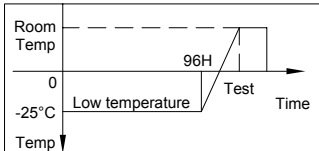
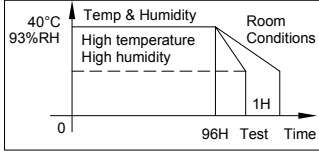
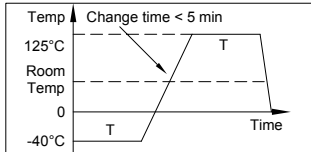
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6. RELIABILITY AND TEST CONDITION :

ITEM	PERFORMANCE	TEST CONDITION
Environmental Tests		
High Temperature Storage Test Reference documents: MIL-STD-202G Method 108A	1. No case deformation or change in appearance. 2. $\Delta L/L \leq 30\%$ (Closed Magnetic Circuit) $\Delta L/L \leq 10\%$ 3. $\Delta Q/Q \leq 30\%$ 4. $\Delta DCR/DCR \leq 10\%$	Temperature : $85 \pm 2^\circ\text{C}$ Time : 96 ± 2 hours Tested after 1 hour (less than 2 hours) at room temperature 
Low Temperature Storage Test Reference documents: IEC 68-2-1A 6.1 6.2	1. No case deformation or change in appearance. 2. $\Delta L/L \leq 30\%$ (Closed Magnetic Circuit) $\Delta L/L \leq 10\%$ 3. $\Delta Q/Q \leq 30\%$ 4. $\Delta DCR/DCR \leq 10\%$	Temperature : $-25 \pm 2^\circ\text{C}$ Time : 96 ± 2 hours Tested after 1 hour (less than 2 hours) at room temperature 
Humidity Test Reference documents: MIL-STD-202G Method 103B	1. No case deformation or change in appearance. 2. $\Delta L/L \leq 30\%$ (Closed Magnetic Circuit) $\Delta L/L \leq 10\%$ 3. $\Delta Q/Q \leq 30\%$ 4. $\Delta DCR/DCR \leq 10\%$	Dry oven at temperature of $40 \pm 5^\circ\text{C}$ for 24 hours Measured after 24 hours Exposure : Temperature : $40 \pm 2^\circ\text{C}$, Humidity : $93 \pm 3\%$ RH, Time : 96 ± 2 hours Tested while the specimens are still in the chamber Tested after 1 hour (less than 2 hours) at room temperature 
Thermal shock test Reference documents: MIL-STD-202G Method 107G	1. No case deformation or change in appearance. 2. $\Delta L/L \leq 30\%$ (Closed Magnetic Circuit) $\Delta L/L \leq 10\%$ 3. $\Delta Q/Q \leq 30\%$ 4. $\Delta DCR/DCR \leq 10\%$ T : weight $\leq 28\text{g}$: 15 Min. $28\text{g} \leq \text{weight} \leq 136\text{g}$: 30 Min.	Conditions of 1 cycle : Step 1 : -40°C for T time Step 2 : 125°C for T time Total : 20 cycles 
Physical Characteristics Tests		
Solderability Test Reference documents: MIL-STD-202G Method 208H IPC J-STD-002B	More than 95% of terminal electrode should be covered with solder.	Solder temperature : $245 \pm 5^\circ\text{C}$ Dip time : 5 secs. Solder : Sn(63)/Pb(37) Flux : rosin flux



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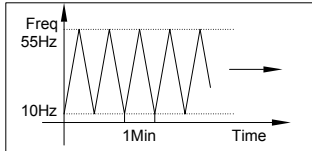
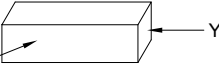
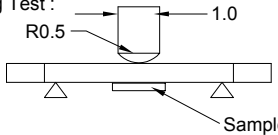
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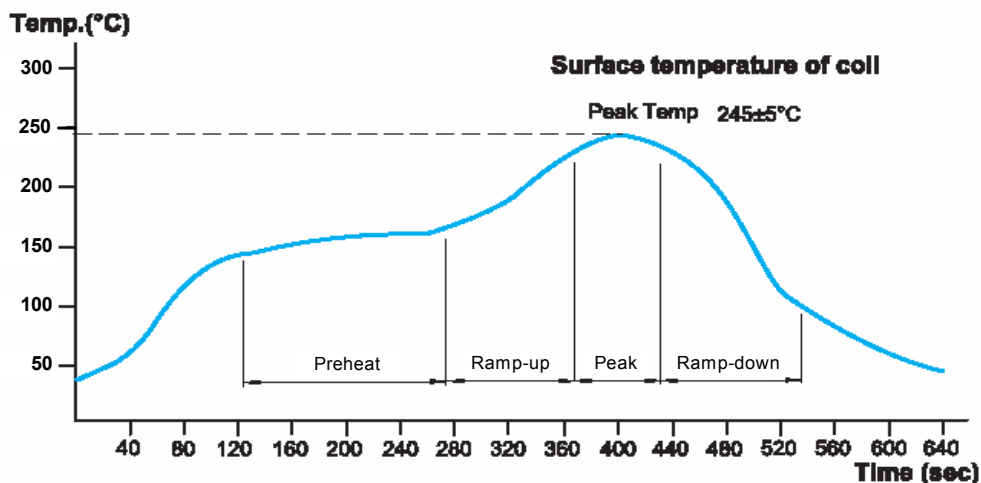


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6. RELIABILITY AND TEST CONDITION :

ITEM	PERFORMANCE	TEST CONDITION												
Heat Endurance of Reflow Soldering Reference documents: IPC J-STD-020B	1. No case deformation or change in appearance. 2. $\Delta L/L \leq 30\%$ (Closed Magnetic Circuit) $\Delta L/L \leq 10\%$ 3. $\Delta Q/Q \leq 30\%$ 4. $\Delta DCR/DCR \leq 10\%$	Refer to reflow curve. No. of cycle : 3 Peak temp. : $245 \pm 5^\circ\text{C}$												
Vibration Test Reference documents: MIL-STD-202G Method 201A	1. No case deformation or change in appearance. 2. $\Delta L/L \leq 30\%$ (Closed Magnetic Circuit) $\Delta L/L \leq 10\%$ 3. $\Delta Q/Q \leq 30\%$ 4. $\Delta DCR/DCR \leq 10\%$	Frequency : 10~55Hz Amplitude : 0.75mm Directions & times : X, Y, Z directions for 2 hours. A period of 2 hours in each of 3 mutually perpendicular directions (Total 6 hours). 												
Drop Test Reference documents: MIL-STD-202G Method 203C	1. No case deformation or change in appearance. 2. $\Delta L/L \leq 30\%$ (Closed Magnetic Circuit) $\Delta L/L \leq 10\%$ 3. $\Delta Q/Q \leq 30\%$ 4. $\Delta DCR/DCR \leq 10\%$	Drop from a height of 1m with 981m/s^2 (100G) altitude (1 angle, 1 ridge and 2 surface orientations)												
Terminal Strength Push Test Reference documents: JIS C 5321:1997	Pulling Test : A : Sectional area of terminal <table border="1" data-bbox="467 1070 852 1193"> <thead> <tr> <th></th> <th>Force</th> <th>Time (sec)</th> </tr> </thead> <tbody> <tr> <td>$A \leq 8\text{mm}^2$</td> <td>$\geq 5\text{N}$</td> <td>30</td> </tr> <tr> <td>$8\text{mm}^2 < A \leq 20\text{mm}^2$</td> <td>$\geq 10\text{N}$</td> <td>10</td> </tr> <tr> <td>$20\text{mm}^2 < A$</td> <td>$\geq 20\text{N}$</td> <td>10</td> </tr> </tbody> </table> Bending Test : The terminal electrode & the dielectric must not be damaged by the forces applied on the right conditions.		Force	Time (sec)	$A \leq 8\text{mm}^2$	$\geq 5\text{N}$	30	$8\text{mm}^2 < A \leq 20\text{mm}^2$	$\geq 10\text{N}$	10	$20\text{mm}^2 < A$	$\geq 20\text{N}$	10	Bend PCB at middle point, the deflection shall be 2mm. Pulling Test :  Bending Test :  Sample
	Force	Time (sec)												
$A \leq 8\text{mm}^2$	$\geq 5\text{N}$	30												
$8\text{mm}^2 < A \leq 20\text{mm}^2$	$\geq 10\text{N}$	10												
$20\text{mm}^2 < A$	$\geq 20\text{N}$	10												

Reflow Curve



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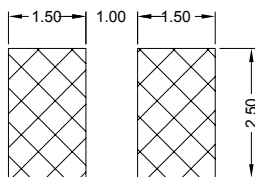
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7. SOLDERING AND MOUNTING :

7-1. Recommended PC Board Pattern



7-2. Soldering

Mildly activated rosin fluxes are preferred. The minimum amount of solder can lead to damage from the stresses caused by the difference in coefficients of expansion between solder, chip and substrate. Our terminations are suitable for all wave and re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.

7-2.1 Solder Re-flow :

Recommended temperature profiles for re-flow soldering in Figure 1.

7-2.2 Solder Wave :

Wave soldering is perhaps the most rigorous of surface mount soldering processes due to the steep rise in temperature seen by the circuit when immersed in the molten solder wave, typical at 240°C. Due to the risk of thermal damage to products, wave soldering of large size products is discouraged. Recommended temperature profile for wave soldering is shown in Figure 2.

7-2.3 Soldering Iron (Figure 2) :

Products attachment with soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended.

Note :

- Preheat circuit and products to 150°C.
- 280°C tip temperature (max)
- Never contact the ceramic with the iron tip
- 1.0mm tip diameter (max)
- Use a 20 watt soldering iron with tip diameter of 1.0mm
- Limit soldering time to 3 secs.

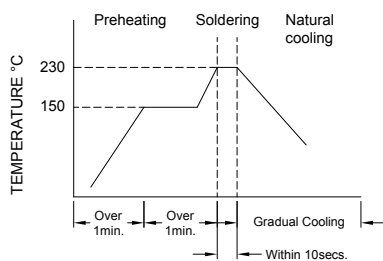


Figure 1. Re-flow Soldering

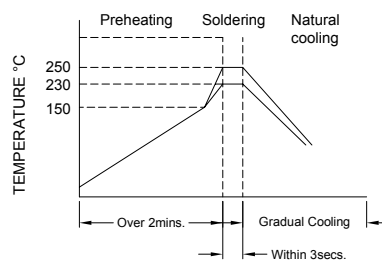


Figure 2. Wave Soldering

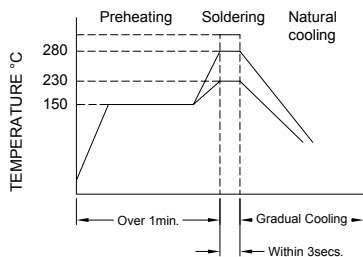


Figure 3. Hand Soldering



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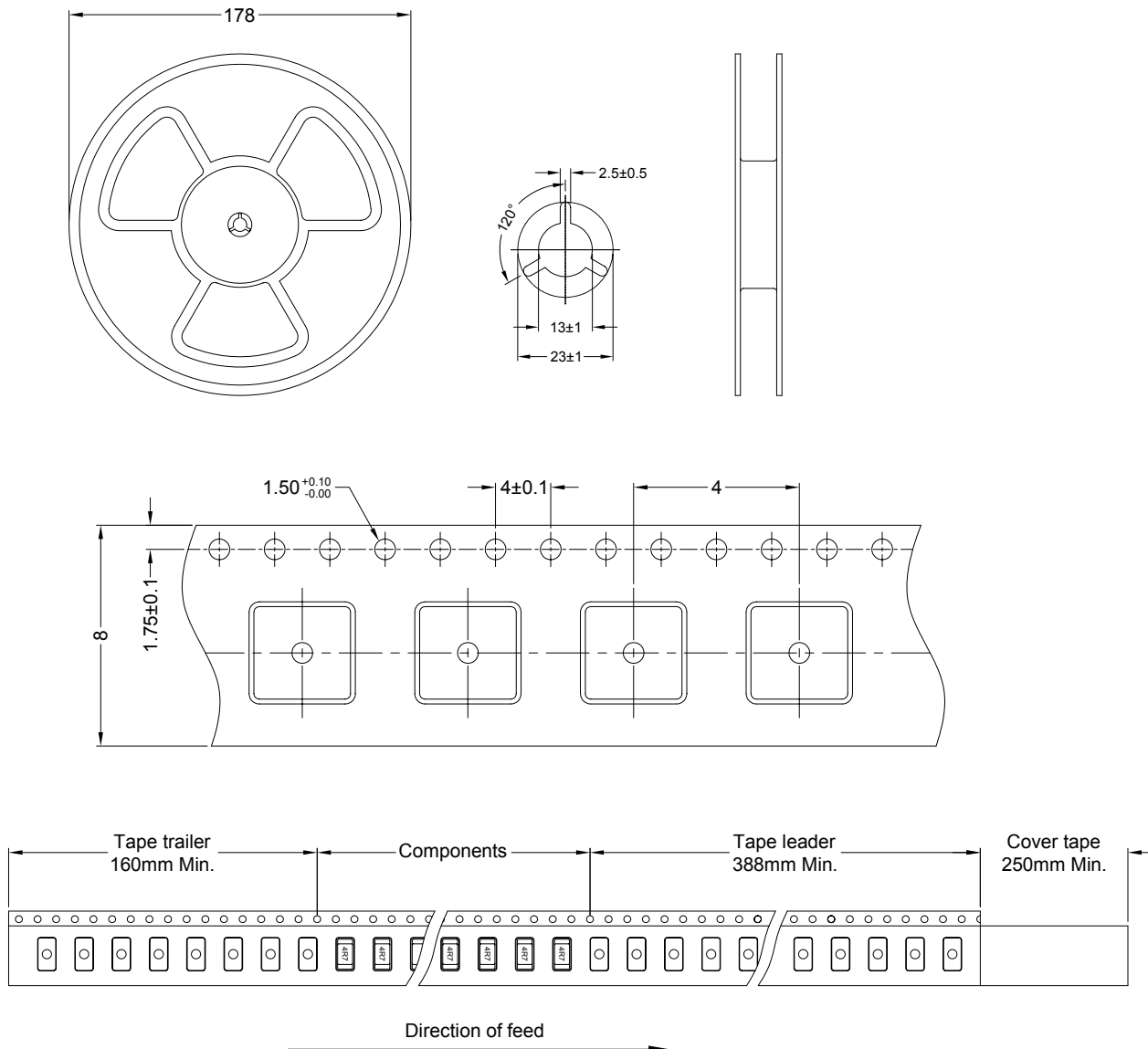


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PG. 6

8. PACKAGING INFORMATION : (Unit : mm)

8-1. Reel & Tape Dimension



8-2. Quantity & G.W. per package

SERIES	INNER : REEL		OUTER : CARTON		
	Q'TY (PCS)	G.W. (Kg)	Q'TY (PCS)	G.W. (Kg)	SIZE (cm)
SDI322520	2000	0.18	120000	15	39 x 39 x 23



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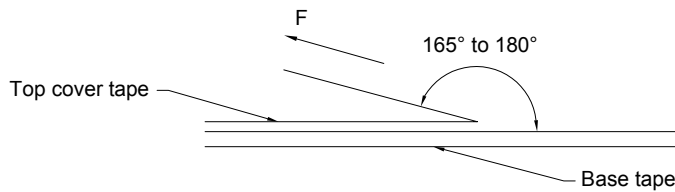
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8-3. Tearing Off Force



The force for tearing off cover tape is 10 to 60 grams in the arrow direction.

Application Notice

1. Storage Conditions :

To maintain the solderability of terminal electrodes :

- a) Temperature and humidity conditions : Less than 40°C and 70% RH.
- b) Recommended products should be used within 6 months from the time of delivery.
- c) The packaging material should be kept where no chlorine or sulfur exists in the air.

2. Transportation :

- a) Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- b) The use of tweezers or vacuum pick up is strongly recommended for individual components.
- c) Bulk handling should ensure that abrasion and mechanical shock are minimized.



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